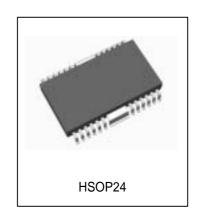




# Dual Full-bridge PWM Stepper Motor Driver

## **Features**

Dual full bridge for a bipolar stepper motor driver
Output current 1.2A, Output voltage 35V
Constant current control(fixed frequency PWM control)
2-bit digital current selection
Noise cancellation function
Built-in flywheel and flyback diodes
Cross conduction protection
Thermal shutdown with hysteresis
Surface mount package with heat sink(HSOP24)

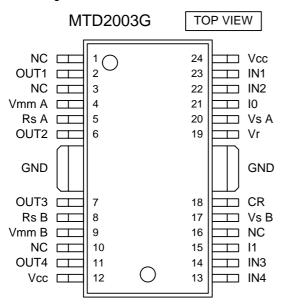


### Absolute maxmum ratings / Ta=25

Parameter	Symbol	Rating	Unit
Output voltage	Vmm	35	V
Output current	I <sub>OUT</sub>	1.2	А
Logic supply	Vcc	0 ~ 6	V
Logic input	$V_{LOGIC}$	0 ~ Vcc	V
Allowable power dissipation *	$P_{D}$	2.1	W
Storge temperature range	Tstg	-40 ~ 150	
Maximum Junction temperature	Tj	150	

<sup>\*50.8 × 50.8 × 1</sup>mm³ Glass Epoxy Board(FR4),200mm² Cupper Pattern

### Pin Assignment



### Truth table

IN 1 or 4	IN 2 or 3	OUT 1 or 4	OUT 2 or 3
L	L	OFF	OFF
L	Н	L	Н
Н	L	Н	L
Н	Н	OFF	OFF

10	I1	Output current ratio[%]	Vref[V] (at Vr=5V)
L	L	100	0.50 ± 5%
Н	L	70	0.35 ± 8%
L	Н	33	0.17 ± 10%
Н	Н	0	-

## **Electrical Characteristics**

Vcc=5V.	Ta=25	unless	otherwise	specified
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			VCC=5V, Ta=	-20 unio	22 Offici Mi2	o specified
Parameter	Symbol	Condition	MIN	TYP	MAX	Unit
Output stage	•	•				•
Upper transistor saturation voltage	$V_{CE(sat)}H$	I <sub>C</sub> =1.0A	-	1.2	1.4	V
Lower transistor saturation voltage	V <sub>CE(sat)</sub> L	I <sub>C</sub> =1.0A	-	0.7	1.0	V
Upper transistor leak current	IrH	Vmm=30V, V <sub>OUT</sub> =0V	-	-	10	μA
Lower transistor leak current	IrL	$V_{OUT}$ =30V, $V_{RS}$ =0V	-	-	10	μA
Uppre diode forward drop	V <sub>F</sub> H	I <sub>F</sub> =1.0A	-	1.4	1.6	V
Lower diode forward drop	V <sub>F</sub> L	I <sub>F</sub> =1.0A	-	1.3	1.5	V
Logic stage						
Logic supply current (2circuit ON)	I <sub>CC(ON)</sub>		-	50	65	mA
Logic supply current (2circuit OFF)	I <sub>CC(OFF)</sub>	V <sub>IN</sub> =all 0V or all 5V	-	15	25	mA
IN "H" input voltage	V <sub>IN</sub> H		2.3	-	Vcc	V
IN "L" input voltage	V <sub>IN</sub> L		GND	-	0.6	V
IN "H" input current	I <sub>IN</sub> H	V <sub>IN</sub> =3.3 or 5V	-	-	10	μA
IN "L" input current	I <sub>IN</sub> L	V <sub>IN</sub> =0V	-	-3	-20	μA
I0,I1 "H"input voltage	V <sub>10/11</sub> H		2.3	-	Vcc	V
I0,I1 "L"input voltage	V <sub>I0/I1</sub> L		GND	-	0.6	V
I0,I1 "H"input current	I <sub>10/11</sub> H	V <sub>I0/I1</sub> =3.3 or 5V	-	-	10	μА
I0,I1 "L"input current	I <sub>10/11</sub> L	V <sub>10/11</sub> =0V	-	-75	-100	μA
Vr input current	Iref	Vr=5V	-	500	650	μA
Vs input current	Is	Vs=0V	-	-1	-10	μA
Comparator threshhold (100%)	Vs1	Vr=5V, V <sub>10</sub> =0V, V <sub>11</sub> =0V	0.475	0.5	0.525	V
Comparator threshhold (70%)	Vs2	Vr=5V, V <sub>10</sub> =5V, V <sub>11</sub> =0V	0.322	0.35	0.378	V
Comparator threshhold (33%)	Vs3	Vr=5V, V <sub>10</sub> =0V, V <sub>11</sub> =5V	0.153	0.17	0.187	V
Chopping frequency	f <sub>CHOP</sub>		-	20	-	kHz
Blanking time	tb	Ct=3300pF	-	1.55	-	μs
Thermal shutdown temperature	T <sub>TSD</sub>		-	150	-	

## Recommended operation conditions

Parameter	Symbol	Recommendation	Unit
Junction temperature	Tj	-25 ~ 120	
Logic supply	Vcc	4.75 ~ 5.25	V
Load supply	Vmm	~ 31	V

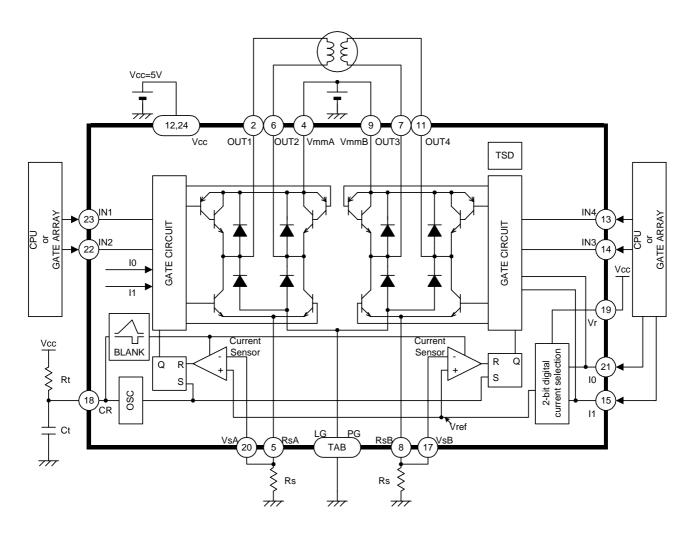
### Thermal resistance

Symbol	Rating	Unit
ja	58	/W

<sup>\*50.8 × 50.8 × 1</sup>mm³ Glass Epoxy Board(FR4),200mm² Cupper Pattern



## Block diagram / Typical application



Constant chopping current level

$$Ichop = \frac{Vr}{10 \times Rs} - 0.015$$

ONE SHOT OFF TIME

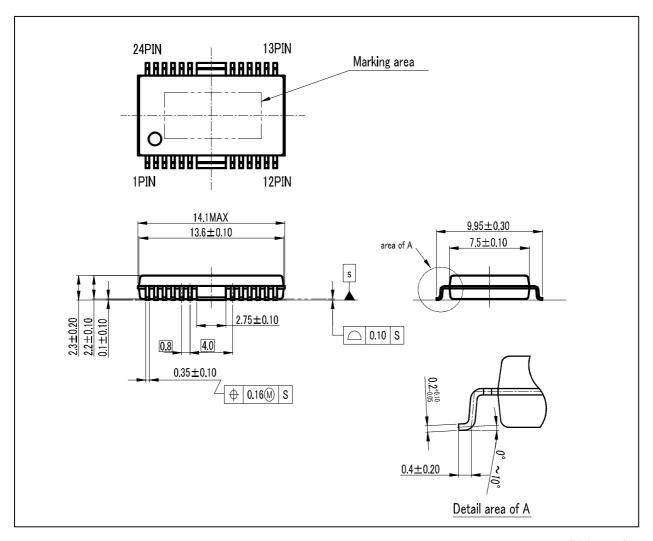
$$f = \frac{1}{0.72 \times Ct \times Rt}$$

#### Recommended component values

Symbol	Recommended component values	Unit
Rt	18	k
Ct	3300	pF
Vr	Vcc	V



## **Outline Drawing**



(Unit: mm)



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